

DMV1500HD

Damper + modulation diode for CRT TV

Features

- Full kit in one package
- High breakdown voltage capability
- Very fast recovery diode
- Specified turn on switching characteristics
- Low static and peak forward voltage drop for low dissipation
- Insulated version:
 - Insulated voltage = 2000 V_{RMS}
 - Capacitance = 7 pF
- Planar technology allowing high quality and best electrical characteristics
- Outstanding performance of well proven DTV as damper and new faster Turbo 2 600 V technology as modulation

Description

High voltage semiconductor especially designed for horizontal deflection stage in standard and high resolution video display with E/W correction.

The insulated TO-220FPAB package includes both the damper diode and the modulation diode, thanks to a dedicated design.

Assembled on automated line, it offers very low dispersion values on insulating and thermal performanes.

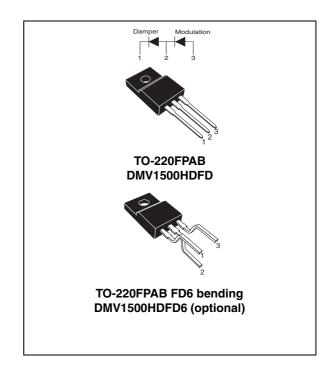


Table 1. Device summary

Symbol	Damper	Modulation
I _{F(AV)}	6 A	3 A
I _{Fpeak} (max)	12 A	12 A
V _{RRM}	1500 V	600 V
t _{rr} (typ)	150 ns	60 ns
V _F (typ)	1.0 V	1.0 V
V _{FP} (typ)	21 V	5 V

Characteristics DMV1500HD

1 Characteristics

Table 2. Absolute maximum ratings

Symbol	Paramete	Va	Unit		
Cymbol	i didilioto.		Damper	Modulation	Onne
V _{RRM}	Repetitive peak reverse voltage		1500	600	٧
I _{Fpeak}	Peak working forward current	F = 56 kHz	12	12	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		75	50	Α
T _{stg}	Storage temperature range		-40 to	+150	°C
Tj	Maximum operating junction temperat	1:	50	°C	

Table 3. Thermal resistance

Symbol	Parameter		Unit
$R_{th(j-c)}$	Junction to case thermal resistance		°C/W

Table 4. Static electrical characteristics

		Test conditions						
Symbol	Parameter			Test conditions		T _j = 2	25 °C	T _j = 1
			ļ		Max.	Тур.	Max.	
ı (1)	I _R ⁽¹⁾ Reverse leakage current	Damper	V _R = 1500 V		100	100	1000	^
'R`		neverse leakage current	Modulation	V _R = 600 V		20	3	50
V _F ⁽²⁾	Porward voltage drop	Damper	I _F = 6 A	1.5	2.3	1.25	1.7	V
V _F `'		Modulation	I _F = 3 A		1.8	1.1	1.4	V

^{1.} Pulse test: $t_p = 5 \text{ ms}, \delta < 2\%$

To evaluate the maximum conduction losses of the **damper** and **modulation** diodes use the following equations :

Damper: $P = 1.05 \times I_{F(AV)} + 0.05 \times I_{F}^{2}_{(RMS)}$ **Modulation**: $P = 0.89 \times I_{F(AV)} + 0.055 \times I_{F}^{2}_{(RMS)}$

Table 5. Recovery characteristics

				Value				
Symbol	Parameter	Test cond	ditions	Dan	nper	Modu	lation	Unit
				Тур.	Max.	Тур.	Max.	
+	Davaga recovery time	I _F = 100 mA I _R =100 mA I _{RR} = 10 mA	T _j = 25 °C	1000		250	400	ns
t _{rr}	Reverse recovery time	$I_F = 1 \text{ A}$ $dI_F/dt = -50$ $A/\mu s V_R = 30 V$	T _j = 25 °C	150	250	60	85	115

^{2.} Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

DMV1500HD Characteristics

Table 6. Turn-on switching characteristics

Symbol Parameter		Test conditions			Value		Unit
Cymbol	T diamotor		rest conditions			Max.	O TILL
+.	Forward recovery time	Damper	$I_F = 6 \text{ A}$ $dI_F/dt = 80 \text{ A/}\mu\text{s}$ $V_{FR} = 3 \text{ V}$	T _j = 100 °C	330	470	ns
t _{fr} Fo	roiward recovery time	Modulation	$I_F = 6 \text{ A}$ $dI_F/dt = 80 \text{ A/}\mu\text{s}$ $V_{FR} = 2 \text{ V}$	T _j = 100 °C	85	125	119
V	Peak forward voltage	Damper	$I_F = 6 A$ $dI_F/dt = 80 A/\mu s$	T _j = 100 °C	21	29	٧
V _{FP}		Modulation	$I_F = 6 A$ $dI_F/dt = 80 A/\mu s$	T _j = 100 °C	5	7.5	V

Figure 1. Power dissipation vs. peak forward Figure 2. Average forward current vs. current (triangular waveform, ambient temperature δ = 0.45)

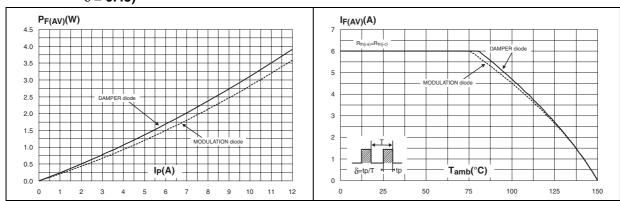
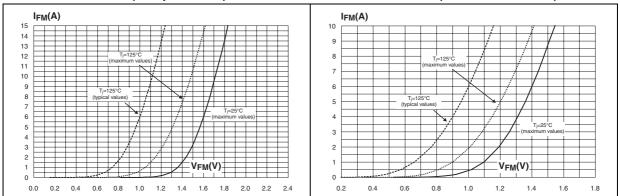


Figure 3. Forward voltage drop vs. forward Figure 4. Forward voltage drop vs. forward current (damper diode) current (modulation diode)



Characteristics DMV1500HD

Figure 5. Relative variation of thermal impedance junction to case versus pulse duration

 $Z_{th(j-c)}/R_{th(j-c)}$ 1.0 0.9 0.8 0.7 0.6 0.5 0.3 0.2 0.1 t_p(s) 0.0 1.E-01 1.E+00 1.E-03 1.E+01 1.E+02

Figure 6. Reverse recovery charges vs. dl_F/dt (damper diode, typical values)

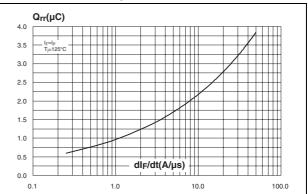


Figure 7. Reverse recovery charges vs. dl_F/dt (modulation diode, typical values)

Values)

Qrr(nC)

250

150

100

50

0.1

1.0

10.0

100.0

Figure 8. Peak reverse recovery current vs. dl_F/dt (damper diode, typical values)

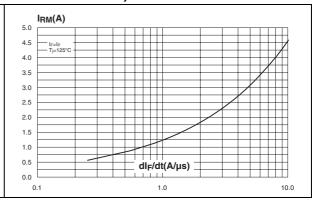


Figure 9. Peak reverse recovery current vs. dl_F/dt (modulation diode, typical values)

dl_F/dt(A/µs)

I_{RM}(A)

4 0

3.02.52.0

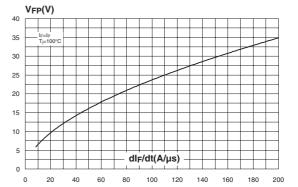
1.5

1.0

0.0



Figure 10. Transient peak forward voltage vs. dl_F/dt (damper diode, typical values)



4/9

DMV1500HD Characteristics

Figure 11. Transient peak forward voltage vs. Figure 12. Forward recovery time vs. dl_F/dt dl_F/dt (modulation diode, typical values)

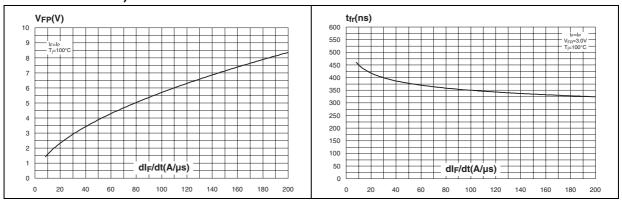


Figure 13. Forward recovery time vs. dl_F/dt (modulation diode, typical values)

Figure 14. Relative variation of dynamic parameters vs. junction temperature

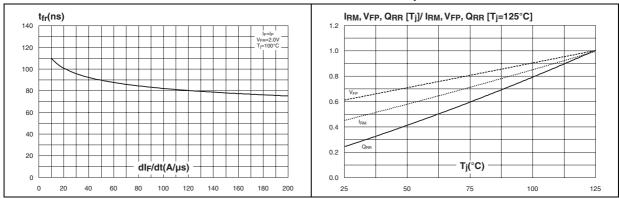
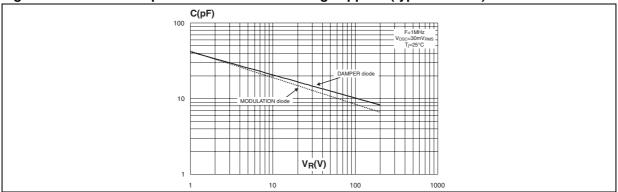


Figure 15. Junction capacitance vs. reverse voltage applied (typical values)



577

Package information DMV1500HD

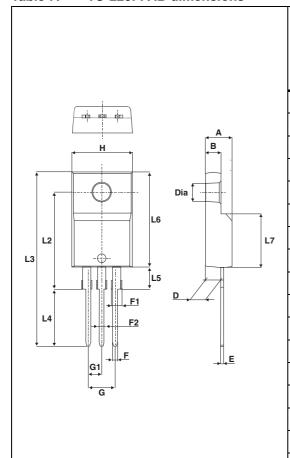
2 Package information

Epoxy meets UL94,V0

Recommended torque: 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at www.st.com

Table 7. TO-220FPAB dimensions

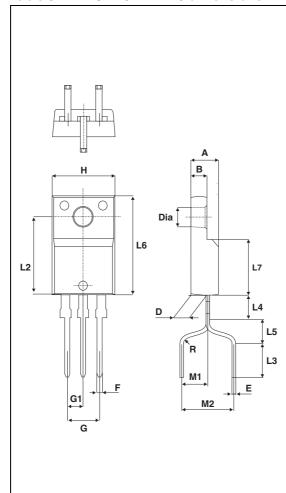


	Dimensions					
Ref.	Millim	neters	Inc	hes		
	Min.	Max.	Min.	Max.		
Α	4.4	4.6	0.173	0.181		
В	2.5	2.7	0.098	0.106		
D	2.5	2.75	0.098	0.108		
Е	0.45	0.70	0.018	0.027		
F	0.75	1	0.030	0.039		
F1	1.15	1.50	0.045	0.059		
F2	1.15	1.50	0.045	0.059		
G	4.95	5.20	0.195	0.205		
G1	2.4	2.7	0.094	0.106		
Η	10	10.4	0.393	0.409		
L2	16	Тур.	0.63 Typ.			
L3	28.6	30.6	1.126	1.205		
L4	9.8	10.6	0.386	0.417		
L5	2.9	3.6	0.114	0.142		
L6	15.9	16.4	0.626	0.646		
L7	9.00	9.30	0.354	0.366		
Dia.	3.00	3.20	0.118	0.126		

6/9

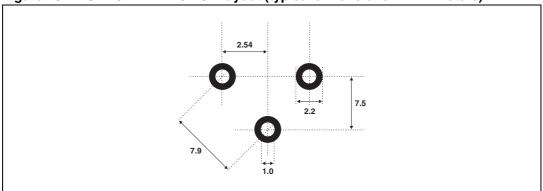
DMV1500HD Package information

Table 8. TO-220FPAB F6 dimensions



	Dimensions					
Ref.	Millim	neters	Inches			
	Min.	Max.	Min.	Max.		
Α	4.4	4.9	0.173	0.192		
В	2.5	2.9	0.098	0.114		
D	2.45	2.75	0.096	0.108		
Е	0.4	0.7	0.016	0.028		
F	0.6	1	0.024	0.039		
G	4.8	5.3	0.195	0.205		
G1	2.2	2.95	0.094	0.106		
Н	10	10.7	0.394	0.421		
L2	12.7	12.8	0.500	0.504		
L3	4.8	Тур.	0.189 Typ.			
L4	3.4	4.8	0.150	0.165		
L5	2.9	Тур.	0.114 Typ.			
L6	15.8	16.4	0.622	0.646		
L7	9	9.9	0.354	0.390		
M1	3.75 Typ.		0.148 Typ.			
M2	7	8	0.276	0.315		
R	1 T	ур.	0.039 Typ.			
Dia.	2.9	3.5	0.114	0.138		

Figure 16. TO-220FPAB FD6 PCB layout (typical dimensions in millimeters)



7/9

Ordering information DMV1500HD

3 Ordering information

 Table 9.
 Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
DMV1500HDFD	DMV1500HD	TO-220FPAB	2.4 g	50	Tube
DMV1500HDFD6	DMV1500HD	TO-220FPAB F6	2.4 g	45	Tube

4 Revision history

Table 10. Document revision history

Date	Revision	Changes
16-Mar-2005	1	Initial release.
02-Dec-2008	2	Reformatted to current standards. Updated ECOPACK statement. Updated dimension illustration for TO-220FPAB FD6 in <i>Table 8</i> .

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

